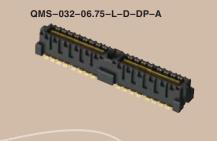
(0,635mm) .025" **QMS SERIES**







RUGGED GROUND PLANE HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?QMS

Insulator Material: Liquid Crystal Polymer Terminal & Ground

Plane Material: Phosphor Bronze Plating:

Au over 50μ" (1,27μm) Ni (Tin on Ground Plane Tail) **Current Rating:** Contact: 1.6A @ 95°C Ground Plane:

9.2A @ 95°C Voltage Rating: 300 VAC mated with QFS Operating Temp: -55°C to +125°C RoHS Compliant:

• Integral guide post **Processing:** Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (026-052) (0,15mm) .006" max (078-104) Board Stacking:

For applications requiring more than two connectors per board or 4 banks or more, contact ipg@samtec.com

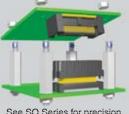


Note: Some lengths, styles and options are non-standard, non-returnable. **Board Mates:**

Cable Mates: Q2DA, 6QCD 6QDP



APPLICATIONS



See SO Series for precision machined standoffs.

insertion depth for rugged applications

11mm Stack Height	Туре	Rated @ 3dB Insertion Loss		
Single-Ended Signaling	–D	8 GHz / 16 Gbps		
Differential Pair Signaling	–D	7.5 GHz / 15 Gbps		
Differential Pair Signaling	-DP	7 GHz / 14 Gbps		
Porformance data for other stack heights and complete				

'erformance data for other stack heights a test data available at www.samtec.com?QMS or contact sig@samtec.com



APPLICATION SPECIFIC

- Power & RF options
- Edge Mount
- Guide Posts
- Without PCB Alignment Pins (05.75 and 06.75 only)
- Hot Pluggable Call Samtec.

 QMS

SAMTEC

insertion depth

Increased

PINS PER ROW NO. OF PAIRS

LEAD STYLE

OPTION

PLATING

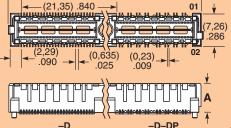
TYPE

OTHER OPTION

–026, –052, -078, –104 (52 total pins per bank = -D)

-016, -032, -048, -064 (16 pairs per bank = -D-DP)

MATED HEIGHT*					
LEAD	Α	QFS LEAD STYLE			
STYLE		-04.25	-06.25		
-05.75	(5,38) .212	10mm	12mm		
-06.75	(6,35) .250	11mm	13mm		
-09.75	(9,35) .368	14mm	16mm		
*Processing conditions will affect mated height.					
(No. of Banks) x (21,34) .840 - (0,51) .02					
<u></u> ← (21,35) .840 <u></u>					



LEAD STYLE from chart

-05.75 and -06.75 lead style only) = 10µ" (0,25µm) Gold on Signal Pins and **Ground Plane** (Gold flash on Signal Pin tails. Tin on Ground Plane tails)

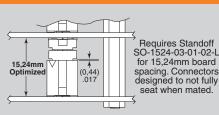
-SL (-09.75 lead style only) = 10μ" (0,25μm) Gold on Signal Pins and **Ground Plane** Tin on Signal Pin tails, and Ground Plane tails)

(0,25) .010 (6,35)

-D= Single-Ended

-D-DP = Differential Pair = (5,50mm) .217" DIA Polyimide film Pick & Place Pad

APPLICATION



INDUSTRY	INTERCONNECTS		
STANDARD	TERMINAL	SOCKET	
StackableUSB™	ASP-129637-01	ASP-129646-01	
SUMIT™	ASP-129637-01	ASP-129646-01	
PCI/104-Express™	ASP-129637-03	ASP-129646-03	

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM